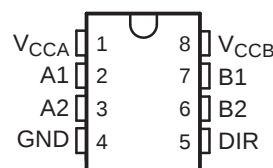


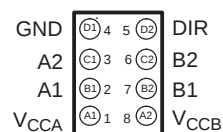
## FEATURES

- Available in the Texas Instruments NanoFree™ Package
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range
- $V_{CC}$  Isolation Feature – If Either  $V_{CC}$  Input Is at GND, Both Ports Are in the High-Impedance State
- DIR Input Circuit Referenced to  $V_{CCA}$
- Low Power Consumption, 10- $\mu$ A Max  $I_{CC}$
- $\pm 24$ -mA Output Drive at 3.3 V
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Max Data Rates
  - 420 Mbps (3.3-V to 5-V Translation)
  - 210 Mbps (Translate to 3.3 V)
  - 140 Mbps (Translate to 2.5 V)
  - 75 Mbps (Translate to 1.8 V)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 4000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

DCT OR DCU PACKAGE  
(TOP VIEW)



YZP PACKAGE  
(BOTTOM VIEW)



## DESCRIPTION/ORDERING INFORMATION

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

### ORDERING INFORMATION

| $T_A$         | PACKAGE <sup>(1)</sup>                                        |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING <sup>(2)</sup> |
|---------------|---------------------------------------------------------------|--------------|-----------------------|---------------------------------|
| –40°C to 85°C | NanoFree – WCSP (DSBGA)<br>0.23-mm Large Bump – YZP (Pb-free) | Reel of 3000 | SN74LVC2T45YZPR       | ___TB_                          |
|               |                                                               | Reel of 250  | SN74LVC2T45DCTT       | CT2_ _ _                        |
|               | SSOP – DCT                                                    | Reel of 3000 | SN74LVC2T45DCUR       | CT2_                            |
|               |                                                               | Reel of 250  | SN74LVC2T45DCUT       |                                 |
|               | VSSOP – DCU                                                   |              |                       |                                 |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).
- (2) DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site.  
 DCU: The actual top-side marking has one additional character that designates the assembly/test site.  
 YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

NanoFree is a trademark of Texas Instruments.

## DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The SN74LVC2T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess  $I_{CC}$  and  $I_{CCZ}$ .

The SN74LVC2T45 is designed so that the DIR input circuit is supplied by  $V_{CCA}$ .

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, both ports are in the high-impedance state.

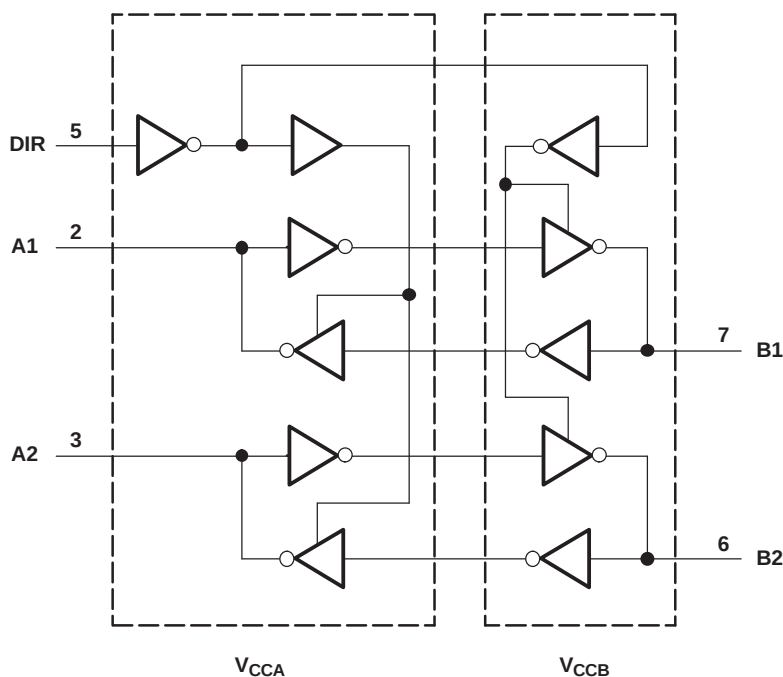
NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

**FUNCTION TABLE<sup>(1)</sup>**  
**(EACH TRANSCEIVER)**

| INPUT DIR | OPERATION       |
|-----------|-----------------|
| L         | B data to A bus |
| H         | A data to B bus |

(1) Input circuits of the data I/Os always are active.

**LOGIC DIAGRAM (POSITIVE LOGIC)**



## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                        |                                                                                             |             | MIN  | MAX             | UNIT |
|------------------------|---------------------------------------------------------------------------------------------|-------------|------|-----------------|------|
| $V_{CCA}$<br>$V_{CCB}$ | Supply voltage range                                                                        |             | –0.5 | 6.5             | V    |
| $V_I$                  | Input voltage range <sup>(2)</sup>                                                          |             | –0.5 | 6.5             | V    |
| $V_O$                  | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> |             | –0.5 | 6.5             | V    |
| $V_O$                  | Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>              | A port      | –0.5 | $V_{CCA} + 0.5$ | V    |
|                        |                                                                                             | B port      | –0.5 | $V_{CCB} + 0.5$ |      |
| $I_{IK}$               | Input clamp current                                                                         | $V_I < 0$   |      | –50             | mA   |
| $I_{OK}$               | Output clamp current                                                                        | $V_O < 0$   |      | –50             | mA   |
| $I_O$                  | Continuous output current                                                                   |             |      | ±50             | mA   |
|                        | Continuous current through $V_{CC}$ or GND                                                  |             |      | ±100            | mA   |
| $\theta_{JA}$          | Package thermal impedance <sup>(4)</sup>                                                    | DCT package |      | 220             | °C/W |
|                        |                                                                                             | DCU package |      | 227             |      |
|                        |                                                                                             | YZP package |      | 102             |      |
| $T_{stg}$              | Storage temperature range                                                                   |             | –65  | 150             | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (3) The value of  $V_{CC}$  is provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

**Recommended Operating Conditions**<sup>(1)(2)(3)</sup>

|                  |                                    |                                                         | V <sub>CCI</sub> | V <sub>CCO</sub> | MIN                     | MAX              | UNIT |
|------------------|------------------------------------|---------------------------------------------------------|------------------|------------------|-------------------------|------------------|------|
| V <sub>CCA</sub> | Supply voltage                     |                                                         |                  |                  | 1.65                    | 5.5              | V    |
| V <sub>CCB</sub> |                                    |                                                         |                  |                  | 1.65                    | 5.5              |      |
| V <sub>IH</sub>  | High-level input voltage           | Data inputs <sup>(4)</sup>                              | 1.65 V to 1.95 V |                  | V <sub>CCI</sub> × 0.65 |                  | V    |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | 1.7                     |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | 2                       |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | V <sub>CCI</sub> × 0.7  |                  |      |
| V <sub>IL</sub>  | Low-level input voltage            | Data inputs <sup>(4)</sup>                              | 1.65 V to 1.95 V |                  | V <sub>CCI</sub> × 0.35 |                  | V    |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | 0.7                     |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | 0.8                     |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | V <sub>CCI</sub> × 0.3  |                  |      |
| V <sub>IH</sub>  | High-level input voltage           | DIR<br>(referenced to V <sub>CCA</sub> ) <sup>(5)</sup> | 1.65 V to 1.95 V |                  | V <sub>CCA</sub> × 0.65 |                  | V    |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | 1.7                     |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | 2                       |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | V <sub>CCA</sub> × 0.7  |                  |      |
| V <sub>IL</sub>  | Low-level input voltage            | DIR<br>(referenced to V <sub>CCA</sub> ) <sup>(5)</sup> | 1.65 V to 1.95 V |                  | V <sub>CCA</sub> × 0.35 |                  | V    |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | 0.7                     |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | 0.8                     |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | V <sub>CCA</sub> × 0.3  |                  |      |
| V <sub>I</sub>   | Input voltage                      |                                                         |                  |                  | 0                       | 5.5              | V    |
| V <sub>O</sub>   | Output voltage                     |                                                         |                  |                  | 0                       | V <sub>CCO</sub> | V    |
| I <sub>OH</sub>  | High-level output current          |                                                         | 1.65 V to 1.95 V |                  | –4                      |                  | mA   |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | –8                      |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | –24                     |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | –32                     |                  |      |
| I <sub>OL</sub>  | Low-level output current           |                                                         | 1.65 V to 1.95 V |                  | 4                       |                  | mA   |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | 8                       |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | 24                      |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | 32                      |                  |      |
| Δt/Δv            | Input transition rise or fall rate | Data inputs                                             | 1.65 V to 1.95 V |                  | 20                      |                  | ns/V |
|                  |                                    |                                                         | 2.3 V to 2.7 V   |                  | 20                      |                  |      |
|                  |                                    |                                                         | 3 V to 3.6 V     |                  | 10                      |                  |      |
|                  |                                    |                                                         | 4.5 V to 5.5 V   |                  | 5                       |                  |      |
|                  | Control input                      |                                                         | 1.65 V to 5.5 V  |                  | 5                       |                  |      |
| T <sub>A</sub>   | Operating free-air temperature     |                                                         |                  |                  | –40                     | 85               | °C   |

(1) V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.(2) V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.(3) All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.(4) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCI</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCI</sub> × 0.3 V.(5) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCA</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCA</sub> × 0.3 V.

## Electrical Characteristics<sup>(1)(2)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                                         |             | TEST CONDITIONS                                                                   | V <sub>CCA</sub>                 | V <sub>CCB</sub> | T <sub>A</sub> = 25°C |     |      | –40°C to 85°C          |     | UNIT |
|---------------------------------------------------|-------------|-----------------------------------------------------------------------------------|----------------------------------|------------------|-----------------------|-----|------|------------------------|-----|------|
|                                                   |             |                                                                                   |                                  |                  | MIN                   | TYP | MAX  | MIN                    | MAX |      |
| V <sub>OH</sub>                                   |             | I <sub>OH</sub> = –100 μA                                                         | V <sub>I</sub> = V <sub>IH</sub> | 1.65 V to 4.5 V  | 1.65 V to 4.5 V       |     |      | V <sub>CCO</sub> – 0.1 | V   |      |
|                                                   |             | I <sub>OH</sub> = –4 mA                                                           |                                  | 1.65 V           | 1.65 V                |     | 1.2  |                        |     |      |
|                                                   |             | I <sub>OH</sub> = –8 mA                                                           |                                  | 2.3 V            | 2.3 V                 |     | 1.9  |                        |     |      |
|                                                   |             | I <sub>OH</sub> = –24 mA                                                          |                                  | 3 V              | 3 V                   |     | 2.4  |                        |     |      |
|                                                   |             | I <sub>OH</sub> = –32 mA                                                          |                                  | 4.5 V            | 4.5 V                 |     | 3.8  |                        |     |      |
| V <sub>OL</sub>                                   |             | I <sub>OL</sub> = 100 μA                                                          | V <sub>I</sub> = V <sub>IL</sub> | 1.65 V to 4.5 V  | 1.65 V to 4.5 V       |     |      | 0.1                    | V   |      |
|                                                   |             | I <sub>OL</sub> = 4 mA                                                            |                                  | 1.65 V           | 1.65 V                |     | 0.45 |                        |     |      |
|                                                   |             | I <sub>OL</sub> = 8 mA                                                            |                                  | 2.3 V            | 2.3 V                 |     | 0.3  |                        |     |      |
|                                                   |             | I <sub>OL</sub> = 24 mA                                                           |                                  | 3 V              | 3 V                   |     | 0.55 |                        |     |      |
|                                                   |             | I <sub>OL</sub> = 32 mA                                                           |                                  | 4.5 V            | 4.5 V                 |     | 0.55 |                        |     |      |
| I <sub>I</sub>                                    | DIR         | V <sub>I</sub> = V <sub>CCA</sub> or GND                                          | 1.65 V to 5.5 V                  | 1.65 V to 5.5 V  |                       |     | ±1   | ±2                     | μA  |      |
| I <sub>off</sub>                                  | A port      | V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V                                     | 0 V                              | 0 to 5.5 V       |                       |     | ±1   | ±2                     | μA  |      |
|                                                   | B port      |                                                                                   | 0 to 5.5 V                       | 0 V              |                       | ±1  | ±2   |                        |     |      |
| I <sub>OZ</sub>                                   | A or B port | V <sub>O</sub> = V <sub>CCO</sub> or GND                                          | 1.65 V to 5.5 V                  | 1.65 V to 5.5 V  |                       |     | ±1   | ±2                     | μA  |      |
| I <sub>CCA</sub>                                  |             | V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0                      | 1.65 V to 5.5 V                  | 1.65 V to 5.5 V  |                       |     |      | 3                      | μA  |      |
|                                                   |             |                                                                                   | 5 V                              | 0 V              |                       |     |      | 2                      |     |      |
|                                                   |             |                                                                                   | 0 V                              | 5 V              |                       |     |      | –2                     |     |      |
| I <sub>CCB</sub>                                  |             | V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0                      | 1.65 V to 5.5 V                  | 1.65 V to 5.5 V  |                       |     |      | 3                      | μA  |      |
|                                                   |             |                                                                                   | 5 V                              | 0 V              |                       |     |      | –2                     |     |      |
|                                                   |             |                                                                                   | 0 V                              | 5 V              |                       |     |      | 2                      |     |      |
| I <sub>CCA</sub> + I <sub>CCB</sub> (see Table 1) |             | V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0                      | 1.65 V to 5.5 V                  | 1.65 V to 5.5 V  |                       |     |      | 4                      | μA  |      |
| ΔI <sub>CCA</sub>                                 | A port      | One A port at V <sub>CCA</sub> – 0.6 V, DIR at V <sub>CCA</sub> , B port = open   | 3 V to 5.5 V                     | 3 V to 5.5 V     |                       |     |      | 50                     | μA  |      |
|                                                   | DIR         | DIR at V <sub>CCA</sub> – 0.6 V, B port = open, A port at V <sub>CCA</sub> or GND |                                  |                  |                       |     |      | 50                     |     |      |
| ΔI <sub>CCB</sub>                                 | B port      | One B port at V <sub>CCB</sub> – 0.6 V, DIR at GND, A port = open                 | 3 V to 5.5 V                     | 3 V to 5.5 V     |                       |     |      | 50                     | μA  |      |
| C <sub>I</sub>                                    | DIR         | V <sub>I</sub> = V <sub>CCA</sub> or GND                                          | 3.3 V                            | 3.3 V            |                       | 2.5 |      |                        | pF  |      |
| C <sub>iO</sub>                                   | A or B port | V <sub>O</sub> = V <sub>CCA/B</sub> or GND                                        | 3.3 V                            | 3.3 V            |                       | 6   |      |                        | pF  |      |

(1) V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.

(2) V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.

**SN74LVC2T45**  
**DUAL-BIT DUAL-SUPPLY BUS TRANSCEIVER**  
**WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS**

SCES516I – DECEMBER 2003 – REVISED MARCH 2007

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (unless otherwise noted) (see [Figure 1](#))

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |      | $V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |      | $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | $V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$ |      | UNIT |
|-----------------|-----------------|----------------|----------------------------------------------|------|---------------------------------------------|------|---------------------------------------------|------|-------------------------------------------|------|------|
|                 |                 |                | MIN                                          | MAX  | MIN                                         | MAX  | MIN                                         | MAX  | MIN                                       | MAX  |      |
| $t_{PLH}$       | A               | B              | 3                                            | 17.7 | 2.2                                         | 10.3 | 1.7                                         | 8.3  | 1.4                                       | 7.2  | ns   |
| $t_{PHL}$       |                 |                | 2.8                                          | 14.3 | 2.2                                         | 8.5  | 1.8                                         | 7.1  | 1.7                                       | 7    |      |
| $t_{PLH}$       | B               | A              | 3                                            | 17.7 | 2.3                                         | 16   | 2.1                                         | 15.5 | 1.9                                       | 15.1 | ns   |
| $t_{PHL}$       |                 |                | 2.8                                          | 14.3 | 2.1                                         | 12.9 | 2                                           | 12.6 | 1.8                                       | 12.2 |      |
| $t_{PHZ}$       | DIR             | A              | 10.6                                         | 30.9 | 10.3                                        | 30.5 | 10.5                                        | 30.5 | 10.7                                      | 29.3 | ns   |
| $t_{PLZ}$       |                 |                | 7.3                                          | 19.7 | 7.5                                         | 19.6 | 7.5                                         | 19.5 | 7                                         | 19.4 |      |
| $t_{PHZ}$       | DIR             | B              | 10                                           | 27.9 | 8.4                                         | 14.9 | 6.5                                         | 11.3 | 4.1                                       | 8.6  | ns   |
| $t_{PLZ}$       |                 |                | 6.5                                          | 19.5 | 7.2                                         | 12.6 | 4.3                                         | 9.7  | 2.1                                       | 7.1  |      |
| $t_{PZH}^{(1)}$ | DIR             | A              |                                              | 37.2 |                                             | 28.6 |                                             | 25.2 |                                           | 22.2 | ns   |
| $t_{PZL}^{(1)}$ |                 |                |                                              | 42.2 |                                             | 27.8 |                                             | 23.9 |                                           | 20.8 |      |
| $t_{PZH}^{(1)}$ | DIR             | B              |                                              | 37.4 |                                             | 29.9 |                                             | 27.8 |                                           | 26.6 | ns   |
| $t_{PZL}^{(1)}$ |                 |                |                                              | 45.2 |                                             | 39   |                                             | 37.6 |                                           | 36.3 |      |

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted) (see [Figure 1](#))

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |      | $V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |      | $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | $V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$ |      | UNIT |
|-----------------|-----------------|----------------|----------------------------------------------|------|---------------------------------------------|------|---------------------------------------------|------|-------------------------------------------|------|------|
|                 |                 |                | MIN                                          | MAX  | MIN                                         | MAX  | MIN                                         | MAX  | MIN                                       | MAX  |      |
| $t_{PLH}$       | A               | B              | 2.3                                          | 16   | 1.5                                         | 8.5  | 1.3                                         | 6.4  | 1.1                                       | 5.1  | ns   |
| $t_{PHL}$       |                 |                | 2.1                                          | 12.9 | 1.4                                         | 7.5  | 1.3                                         | 5.4  | 0.9                                       | 4.6  |      |
| $t_{PLH}$       | B               | A              | 2.2                                          | 10.3 | 1.5                                         | 8.5  | 1.4                                         | 8    | 1                                         | 7.5  | ns   |
| $t_{PHL}$       |                 |                | 2.2                                          | 8.5  | 1.4                                         | 7.5  | 1.3                                         | 7    | 0.9                                       | 6.2  |      |
| $t_{PHZ}$       | DIR             | A              | 6.6                                          | 17.1 | 7.1                                         | 16.8 | 6.8                                         | 16.8 | 5.2                                       | 16.5 | ns   |
| $t_{PLZ}$       |                 |                | 5.3                                          | 12.6 | 5.2                                         | 12.5 | 4.9                                         | 12.3 | 4.8                                       | 12.3 |      |
| $t_{PHZ}$       | DIR             | B              | 10.7                                         | 27.9 | 8.1                                         | 13.9 | 5.8                                         | 10.5 | 3.5                                       | 7.6  | ns   |
| $t_{PLZ}$       |                 |                | 7.8                                          | 18.9 | 6.2                                         | 11.2 | 3.6                                         | 8.9  | 1.4                                       | 6.2  |      |
| $t_{PZH}^{(1)}$ | DIR             | A              |                                              | 29.2 |                                             | 19.7 |                                             | 16.9 |                                           | 13.7 | ns   |
| $t_{PZL}^{(1)}$ |                 |                |                                              | 36.4 |                                             | 21.4 |                                             | 17.5 |                                           | 13.8 |      |
| $t_{PZH}^{(1)}$ | DIR             | B              |                                              | 28.6 |                                             | 21   |                                             | 18.7 |                                           | 17.4 | ns   |
| $t_{PZL}^{(1)}$ |                 |                |                                              | 30   |                                             | 24.3 |                                             | 22.2 |                                           | 21.1 |      |

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see [Figure 1](#))

| PARAMETER                       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.8 V<br>± 0.15 V |      | V <sub>CCB</sub> = 2.5 V<br>± 0.2 V |      | V <sub>CCB</sub> = 3.3 V<br>± 0.3 V |      | V <sub>CCB</sub> = 5 V<br>± 0.5 V |      | UNIT |
|---------------------------------|-----------------|----------------|--------------------------------------|------|-------------------------------------|------|-------------------------------------|------|-----------------------------------|------|------|
|                                 |                 |                | MIN                                  | MAX  | MIN                                 | MAX  | MIN                                 | MAX  | MIN                               | MAX  |      |
| t <sub>PLH</sub>                | A               | B              | 2.1                                  | 15.5 | 1.4                                 | 8    | 0.7                                 | 5.6  | 0.7                               | 4.4  | ns   |
| t <sub>PHL</sub>                |                 |                | 2                                    | 12.6 | 1.3                                 | 7    | 0.8                                 | 5    | 0.7                               | 4    |      |
| t <sub>PLH</sub>                | B               | A              | 1.7                                  | 8.3  | 1.3                                 | 6.4  | 0.7                                 | 5.8  | 0.6                               | 5.4  | ns   |
| t <sub>PHL</sub>                |                 |                | 1.8                                  | 7.1  | 1.3                                 | 5.4  | 0.8                                 | 5    | 0.7                               | 4.5  |      |
| t <sub>PHZ</sub>                | DIR             | A              | 5                                    | 10.9 | 5.1                                 | 10.8 | 5                                   | 10.8 | 5                                 | 10.4 | ns   |
| t <sub>PLZ</sub>                |                 |                | 3.4                                  | 8.4  | 3.7                                 | 8.4  | 3.9                                 | 8.1  | 3.3                               | 7.8  |      |
| t <sub>PHZ</sub>                | DIR             | B              | 11.2                                 | 27.3 | 8                                   | 13.7 | 5.8                                 | 10.4 | 2.9                               | 7.4  | ns   |
| t <sub>PLZ</sub>                |                 |                | 9.4                                  | 17.7 | 5.6                                 | 11.3 | 4.3                                 | 8.3  | 1                                 | 5.6  |      |
| t <sub>PZH</sub> <sup>(1)</sup> | DIR             | A              | 26                                   |      | 17.7                                |      | 14.1                                |      | 11                                |      | ns   |
| t <sub>PZL</sub> <sup>(1)</sup> |                 |                | 34.4                                 |      | 19.1                                |      | 15.4                                |      | 11.9                              |      |      |
| t <sub>PZH</sub> <sup>(1)</sup> | DIR             | B              | 23.9                                 |      | 16.4                                |      | 13.9                                |      | 12.2                              |      | ns   |
| t <sub>PZL</sub> <sup>(1)</sup> |                 |                | 23.5                                 |      | 17.8                                |      | 15.8                                |      | 14.4                              |      |      |

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see [Figure 1](#))

| PARAMETER                       | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CCB} = 1.8\text{ V}$<br>$\pm 0.15\text{ V}$ |      | $V_{CCB} = 2.5\text{ V}$<br>$\pm 0.2\text{ V}$ |      | $V_{CCB} = 3.3\text{ V}$<br>$\pm 0.3\text{ V}$ |      | $V_{CCB} = 5\text{ V}$<br>$\pm 0.5\text{ V}$ |     | UNIT |
|---------------------------------|-----------------|----------------|-------------------------------------------------|------|------------------------------------------------|------|------------------------------------------------|------|----------------------------------------------|-----|------|
|                                 |                 |                | MIN                                             | MAX  | MIN                                            | MAX  | MIN                                            | MAX  | MIN                                          | MAX |      |
| t <sub>PLH</sub>                | A               | B              | 1.9                                             | 15.1 | 1                                              | 7.5  | 0.6                                            | 5.4  | 0.5                                          | 3.9 | ns   |
| t <sub>PHL</sub>                |                 |                | 1.8                                             | 12.2 | 0.9                                            | 6.2  | 0.7                                            | 4.5  | 0.5                                          | 3.5 |      |
| t <sub>PLH</sub>                | B               | A              | 1.4                                             | 7.2  | 1                                              | 5.1  | 0.7                                            | 4.4  | 0.5                                          | 3.9 | ns   |
| t <sub>PHL</sub>                |                 |                | 1.7                                             | 7    | 0.9                                            | 4.6  | 0.7                                            | 4    | 0.5                                          | 3.5 |      |
| t <sub>PHZ</sub>                | DIR             | A              | 2.9                                             | 8.2  | 2.9                                            | 7.9  | 2.8                                            | 7.9  | 2.2                                          | 7.8 | ns   |
| t <sub>PLZ</sub>                |                 |                | 1.4                                             | 6.9  | 1.3                                            | 6.7  | 0.7                                            | 6.7  | 0.7                                          | 6.6 |      |
| t <sub>PHZ</sub>                | DIR             | B              | 11.2                                            | 26.1 | 7.2                                            | 13.9 | 5.8                                            | 10.1 | 1.3                                          | 7.3 | ns   |
| t <sub>PLZ</sub>                |                 |                | 8.4                                             | 16.9 | 5                                              | 11   | 4                                              | 7.7  | 1                                            | 5.6 |      |
| t <sub>PZH</sub> <sup>(1)</sup> | DIR             | A              | 24.1                                            |      | 16.1                                           |      | 12.1                                           |      | 9.5                                          |     | ns   |
| t <sub>PZL</sub> <sup>(1)</sup> |                 |                | 33.1                                            |      | 18.5                                           |      | 14.1                                           |      | 10.8                                         |     |      |
| t <sub>PZH</sub> <sup>(1)</sup> | DIR             | B              | 22                                              |      | 14.2                                           |      | 12.1                                           |      | 10.5                                         |     | ns   |
| t <sub>PZL</sub> <sup>(1)</sup> |                 |                | 20.4                                            |      | 14.1                                           |      | 12.4                                           |      | 11.3                                         |     |      |

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

**SN74LVC2T45**  
**DUAL-BIT DUAL-SUPPLY BUS TRANSCEIVER**  
**WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS**

SCES516I – DECEMBER 2003 – REVISED MARCH 2007

## Operating Characteristics

$T_A = 25^\circ\text{C}$

| PARAMETER       |                                | TEST CONDITIONS                                                             | $V_{CCA} =$<br>$V_{CCB} = 1.8\text{ V}$ | $V_{CCA} =$<br>$V_{CCB} = 2.5\text{ V}$ | $V_{CCA} =$<br>$V_{CCB} = 3.3\text{ V}$ | $V_{CCA} =$<br>$V_{CCB} = 5\text{ V}$ | UNIT |
|-----------------|--------------------------------|-----------------------------------------------------------------------------|-----------------------------------------|-----------------------------------------|-----------------------------------------|---------------------------------------|------|
|                 |                                |                                                                             | TYP                                     | TYP                                     | TYP                                     | TYP                                   |      |
| $C_{pdA}^{(1)}$ | A-port input,<br>B-port output | $C_L = 0\text{ pF}$ ,<br>$f = 10\text{ MHz}$ ,<br>$t_r = t_f = 1\text{ ns}$ | 3                                       | 4                                       | 4                                       | 4                                     | pF   |
|                 | B-port input,<br>A-port output |                                                                             | 18                                      | 19                                      | 20                                      | 21                                    |      |
| $C_{pdB}^{(1)}$ | A-port input,<br>B-port output | $C_L = 0\text{ pF}$ ,<br>$f = 10\text{ MHz}$ ,<br>$t_r = t_f = 1\text{ ns}$ | 18                                      | 19                                      | 20                                      | 21                                    | pF   |
|                 | B-port input,<br>A-port output |                                                                             | 3                                       | 4                                       | 4                                       | 4                                     |      |

(1) Power dissipation capacitance per transceiver

### Power-Up Considerations

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

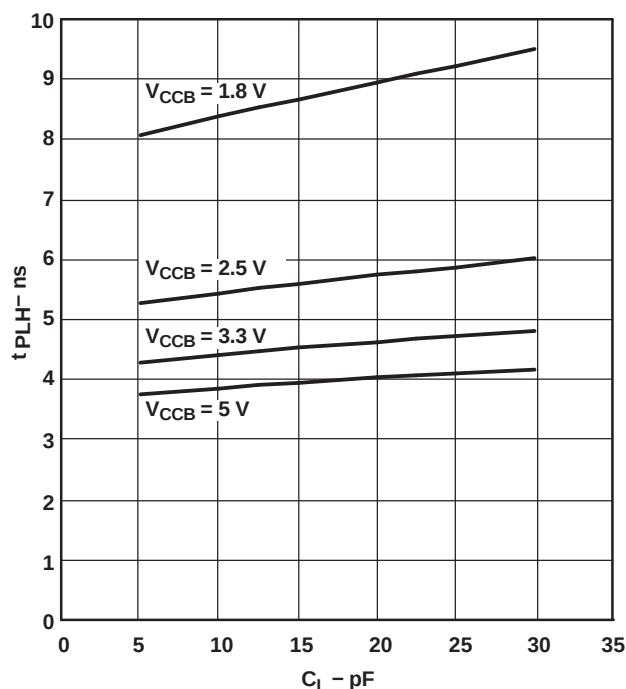
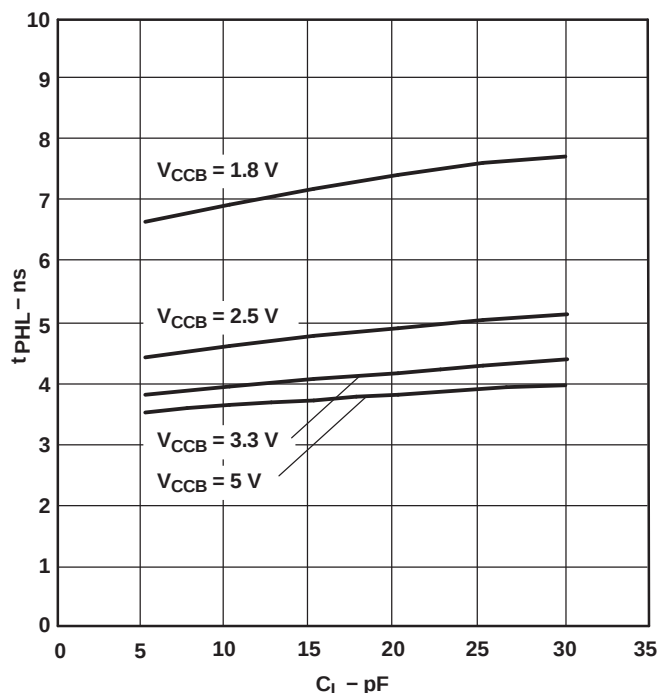
1. Connect ground before any supply voltage is applied.
2. Power up  $V_{CCA}$ .
3.  $V_{CCB}$  can be ramped up along with or after  $V_{CCA}$ .

**Table 1. Typical Total Static Power Consumption ( $I_{CCA} + I_{CCB}$ )**

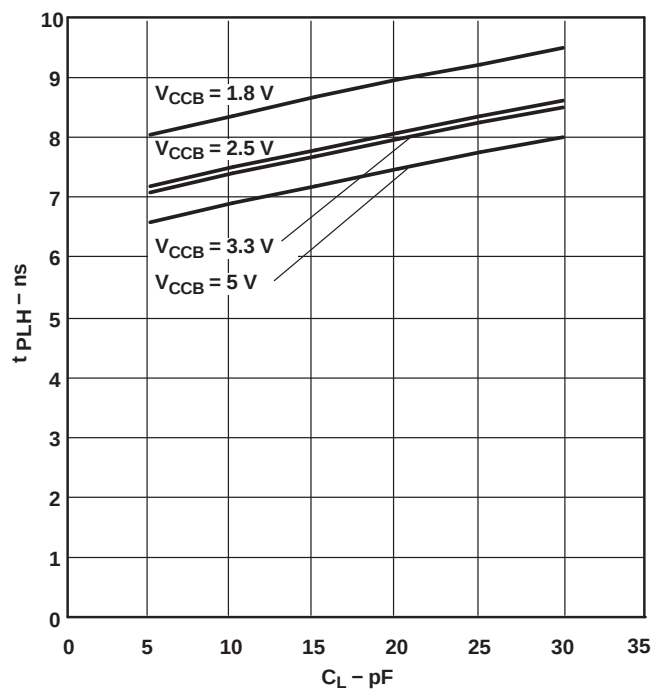
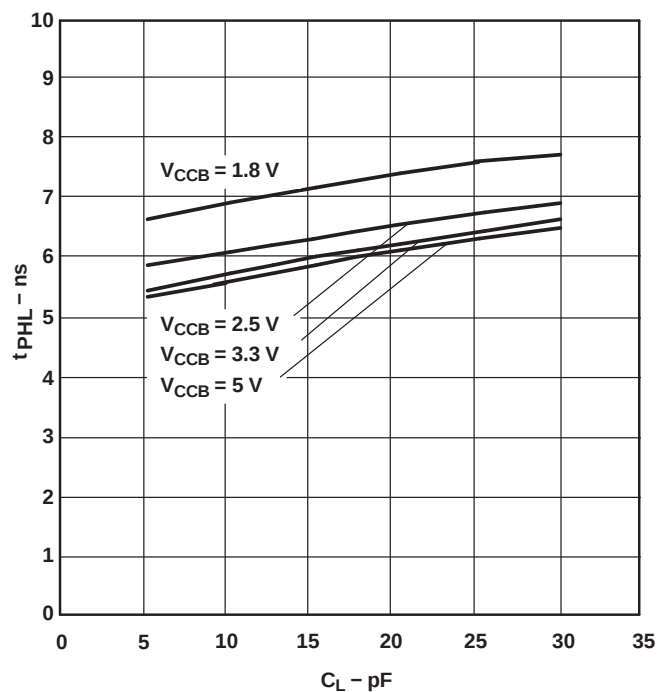
| $V_{CCB}$ | $V_{CCA}$ |       |       |       |     | UNIT    |
|-----------|-----------|-------|-------|-------|-----|---------|
|           | 0 V       | 1.8 V | 2.5 V | 3.3 V | 5 V |         |
| 0 V       | 0         | <1    | <1    | <1    | <1  | $\mu A$ |
| 1.8 V     | <1        | <2    | <2    | <2    | 2   |         |
| 2.5 V     | <1        | <2    | <2    | <2    | <2  |         |
| 3.3 V     | <1        | <2    | <2    | <2    | <2  |         |
| 5 V       | <1        | 2     | <2    | <2    | <2  |         |

## TYPICAL CHARACTERISTICS

**TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE**  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.8\text{ V}$



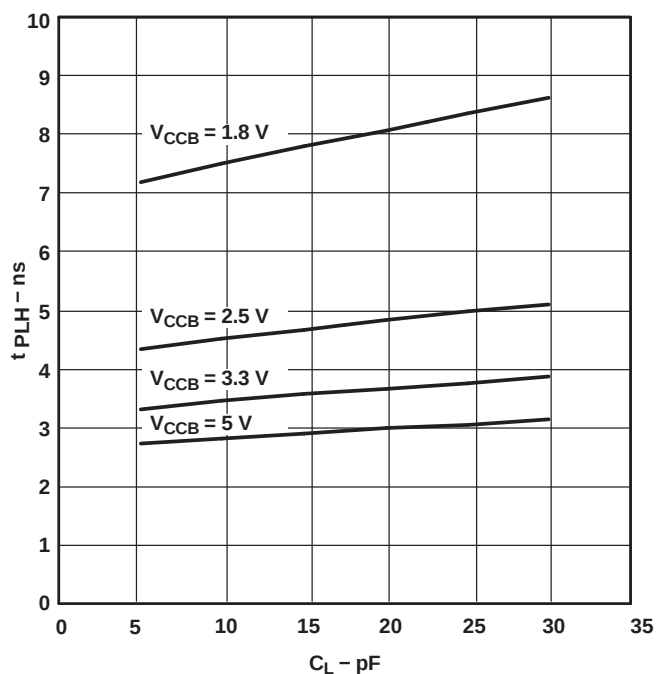
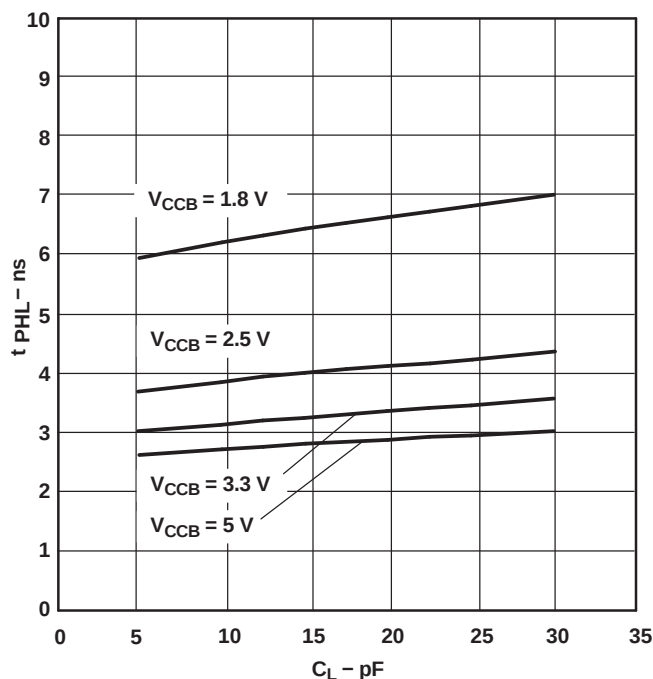
**TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE**  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.8\text{ V}$



## TYPICAL CHARACTERISTICS

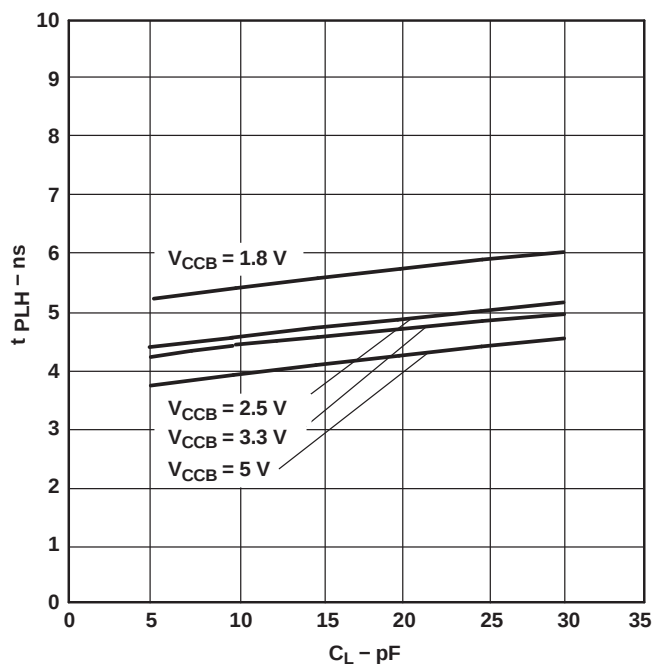
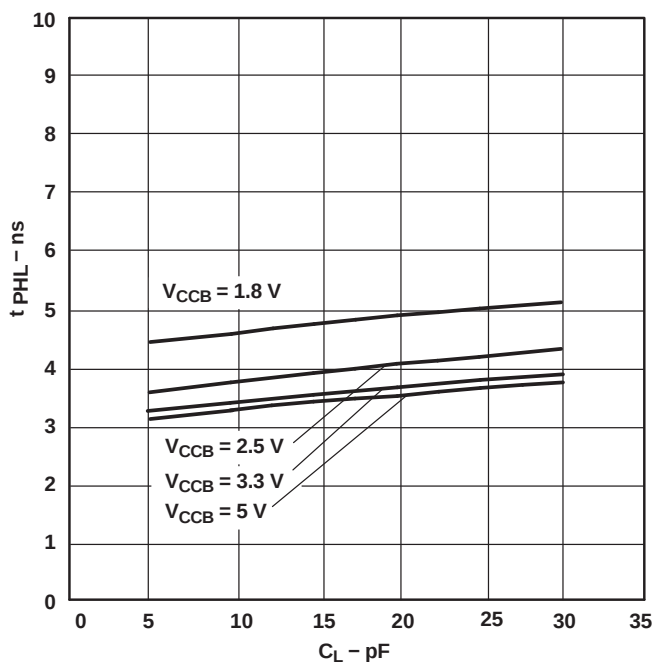
### TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE

$T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 2.5\text{ V}$



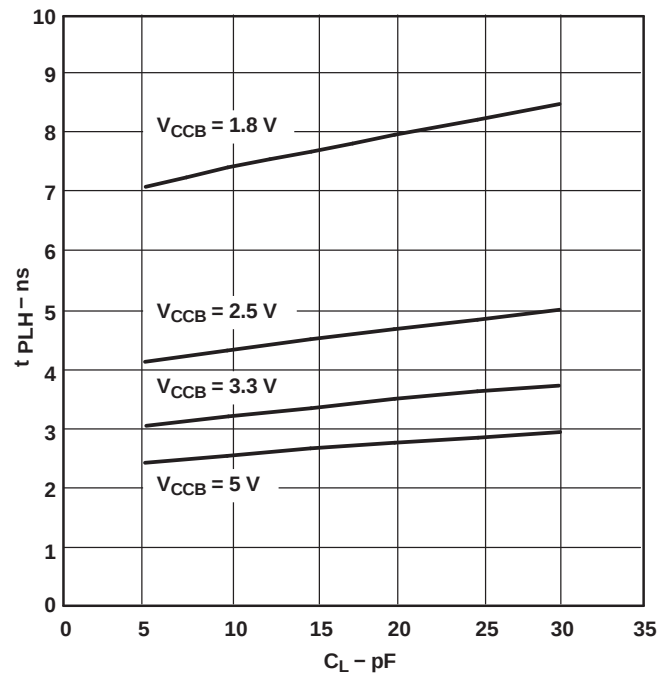
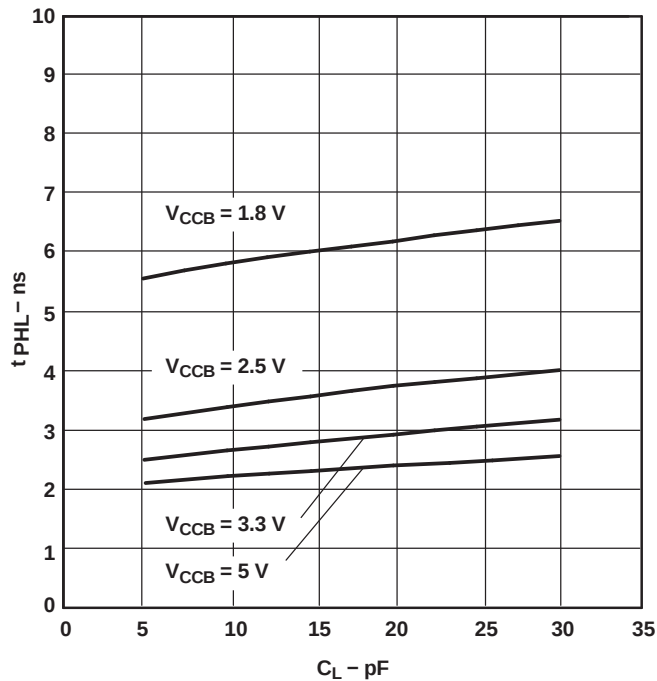
### TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE

$T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 2.5\text{ V}$

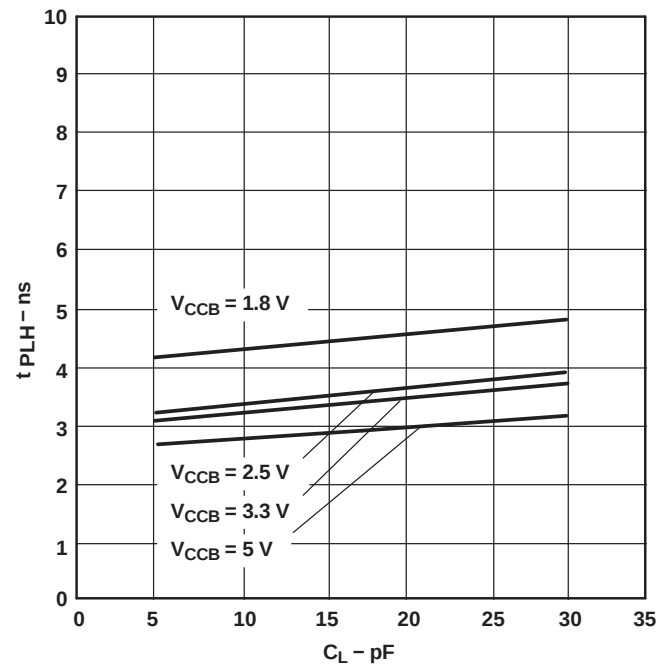
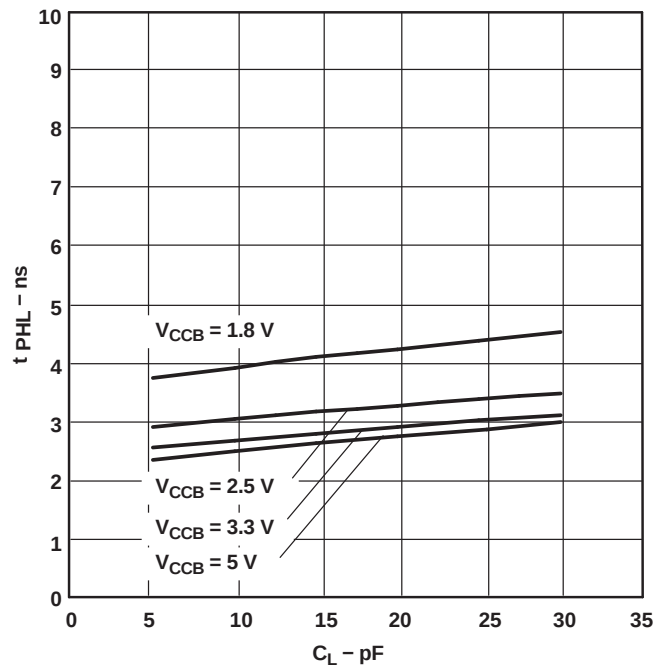


## TYPICAL CHARACTERISTICS

### TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE $T_A = 25^\circ\text{C}$ , $V_{CCA} = 3.3\text{ V}$



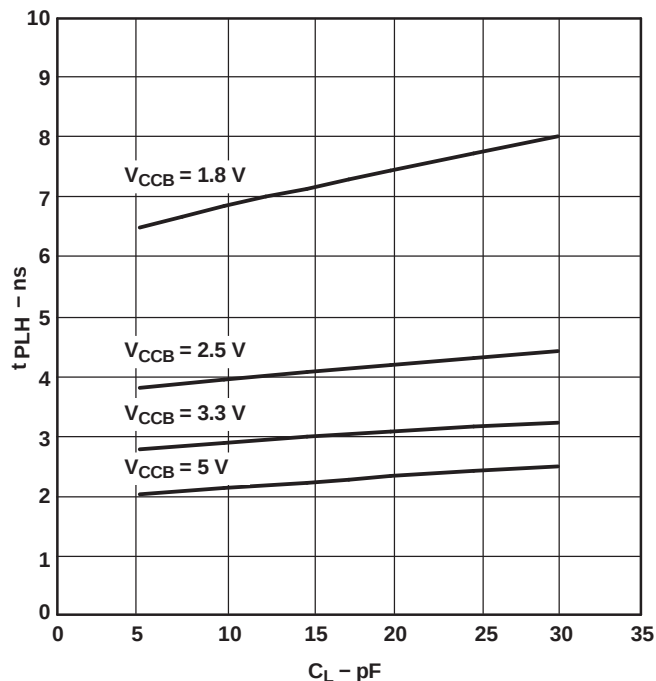
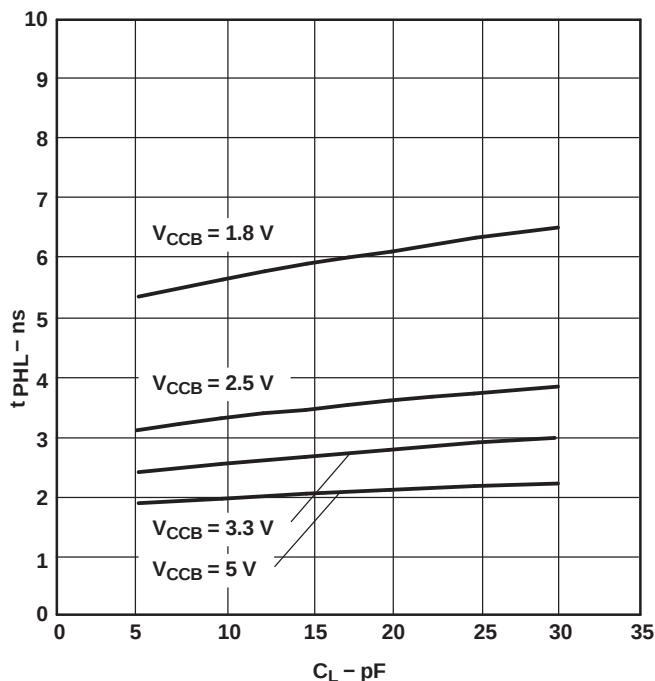
### TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE $T_A = 25^\circ\text{C}$ , $V_{CCA} = 3.3\text{ V}$



## TYPICAL CHARACTERISTICS

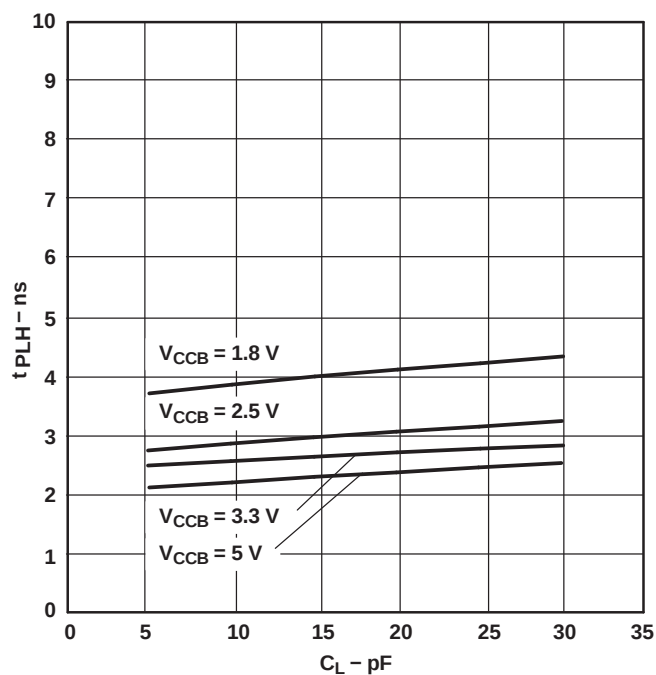
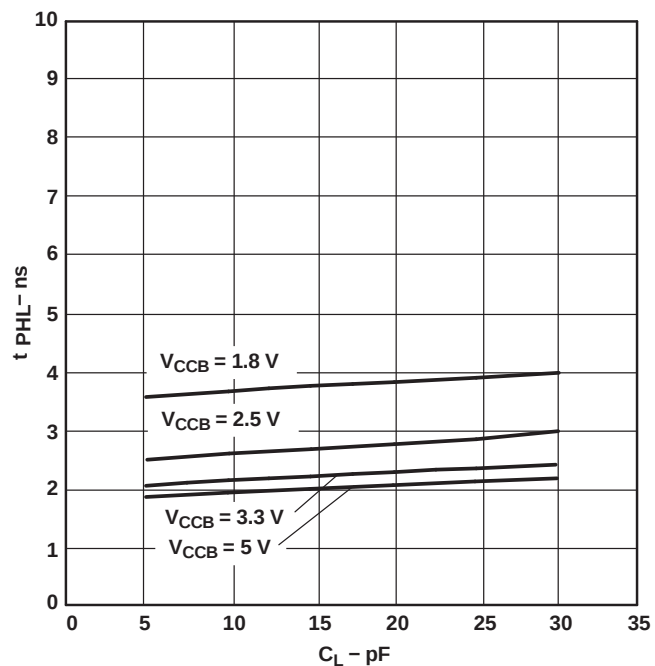
### TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE

$T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 5\text{ V}$

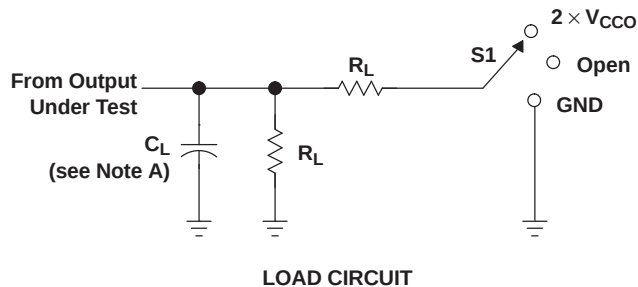


### TYPICAL PROPAGATION DELAY (B to A) vs LOAD CAPACITANCE

$T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 5\text{ V}$

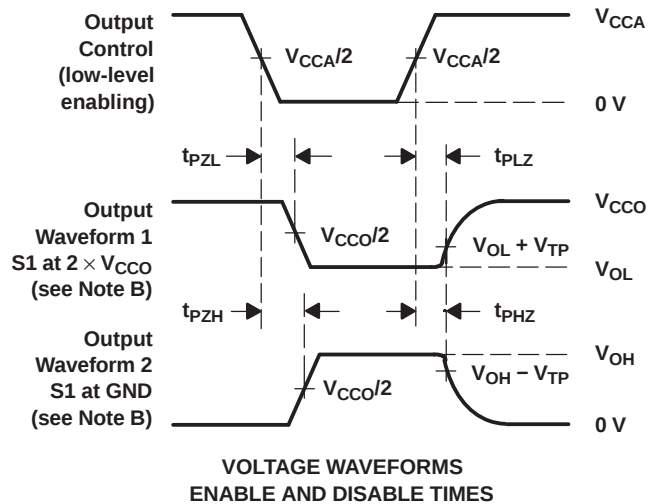
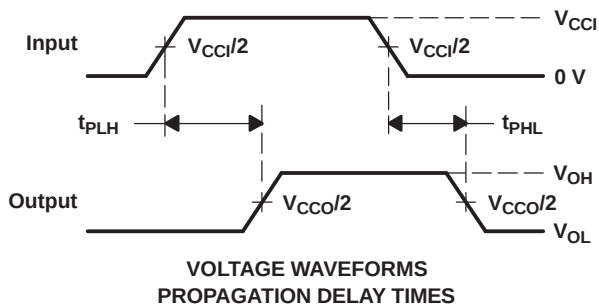
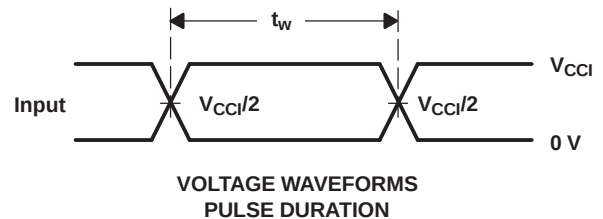


## PARAMETER MEASUREMENT INFORMATION



| TEST              | S1                 |
|-------------------|--------------------|
| $t_{pd}$          | Open               |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CCO}$ |
| $t_{PHZ}/t_{PZH}$ | GND                |

| $V_{CCO}$                          | $C_L$ | $R_L$        | $V_{TP}$ |
|------------------------------------|-------|--------------|----------|
| $1.8 \text{ V} \pm 0.15 \text{ V}$ | 15 pF | 2 k $\Omega$ | 0.15 V   |
| $2.5 \text{ V} \pm 0.2 \text{ V}$  | 15 pF | 2 k $\Omega$ | 0.15 V   |
| $3.3 \text{ V} \pm 0.3 \text{ V}$  | 15 pF | 2 k $\Omega$ | 0.3 V    |
| $5 \text{ V} \pm 0.5 \text{ V}$    | 15 pF | 2 k $\Omega$ | 0.3 V    |

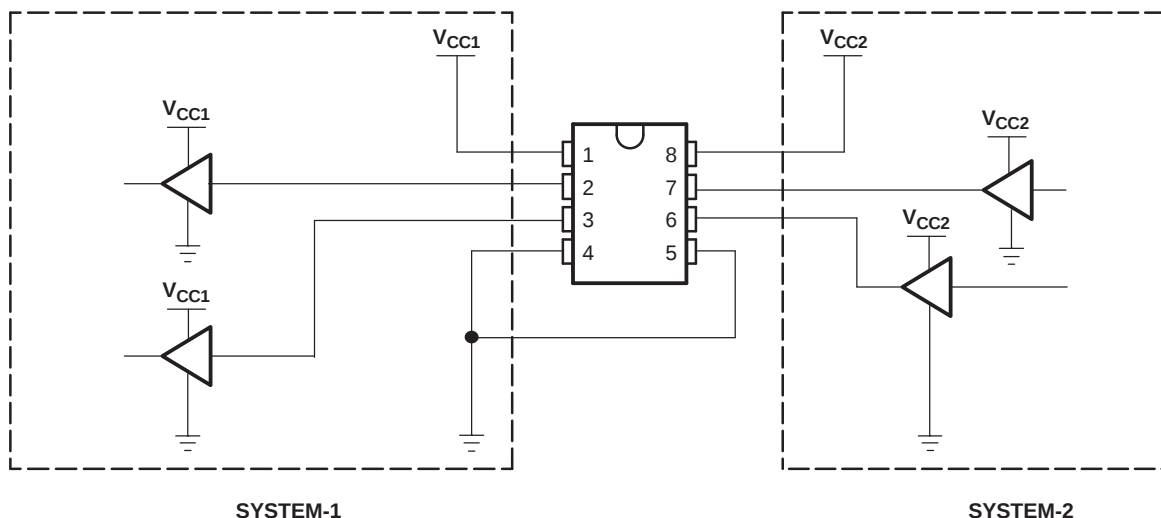


- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $dv/dt \geq 1 \text{ V/ns}$ .
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
  - $V_{CCO}$  is the  $V_{CC}$  associated with the output port.
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

## APPLICATION INFORMATION

The following shows an example of the SN74LVC2T45 being used in a unidirectional logic level-shifting application.



| PIN | NAME             | FUNCTION         | DESCRIPTION                                                |
|-----|------------------|------------------|------------------------------------------------------------|
| 1   | V <sub>CCA</sub> | V <sub>CC1</sub> | SYSTEM-1 supply voltage (1.65 V to 5.5 V)                  |
| 2   | A1               | OUT1             | Output level depends on V <sub>CC1</sub> voltage.          |
| 3   | A2               | OUT2             | Output level depends on V <sub>CC1</sub> voltage.          |
| 4   | GND              | GND              | Device GND                                                 |
| 5   | DIR              | DIR              | GND (low level) determines B-port to A-port direction.     |
| 6   | B2               | IN2              | Input threshold value depends on V <sub>CC2</sub> voltage. |
| 7   | B1               | IN1              | Input threshold value depends on V <sub>CC2</sub> voltage. |
| 8   | V <sub>CCB</sub> | V <sub>CC2</sub> | SYSTEM-2 supply voltage (1.65 V to 5.5 V)                  |

**Figure 2. Unidirectional Logic Level-Shifting Application**

The diagram illustrates a bidirectional I/O connection between two systems, SYSTEM-1 and SYSTEM-2, using a 4-bit bus.

**SYSTEM-1 (Left):**

- Contains an I/O-1 block with two tri-state buffers. The top buffer's output is connected to the bus line for bit 1. The bottom buffer's output is connected to the bus line for bit 4.
- A Pullup/Down or Bus Hold(1) block is connected to the bus lines for bits 1, 2, 3, and 4.
- The system is powered by  $V_{CC1}$  and ground.

**4-bit Bus:**

- The bus consists of four lines, numbered 1 through 4.
- Each line is connected to a corresponding pin on the 4-bit bus component.
- The bus lines are connected to the I/O-2 block in SYSTEM-2.

**SYSTEM-2 (Right):**

- Contains an I/O-2 block with two tri-state buffers. The top buffer's output is connected to the bus line for bit 1. The bottom buffer's output is connected to the bus line for bit 4.
- A Pullup/Down or Bus Hold(1) block is connected to the bus lines for bits 1, 2, 3, and 4.
- The system is powered by  $V_{CC2}$  and ground.

| STATE | DIR CTRL | I/O-1 | I/O-2 | DESCRIPTION                                                                                                                                        |
|-------|----------|-------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------|
| 1     | H        | Out   | In    | SYSTEM-1 data to SYSTEM-2                                                                                                                          |
| 2     | H        | Hi-Z  | Hi-Z  | SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown. <sup>(1)</sup> |
| 3     | L        | Hi-Z  | Hi-Z  | DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. <sup>(1)</sup>                           |
| 4     | L        | In    | Out   | SYSTEM-2 data to SYSTEM-1                                                                                                                          |

### Figure 3. Bidirectional Logic Level-Shifting Application

- $t_{PZH}$  (DIR to A) =  $t_{PLZ}$  (DIR to B) +  $t_{PLH}$  (B to A)
- $t_{PZL}$  (DIR to A) =  $t_{PHZ}$  (DIR to B) +  $t_{PHL}$  (B to A)
- $t_{PZH}$  (DIR to B) =  $t_{PLZ}$  (DIR to A) +  $t_{PLH}$  (A to B)
- $t_{PZL}$  (DIR to B) =  $t_{PHZ}$  (DIR to A) +  $t_{PHL}$  (A to B)

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## PACKAGING INFORMATION

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|-------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| SN74LVC2T45DCTR   | ACTIVE        | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2<br>Z                 | <a href="#">Samples</a> |
| SN74LVC2T45DCTRE4 | ACTIVE        | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2<br>Z                 | <a href="#">Samples</a> |
| SN74LVC2T45DCTRG4 | ACTIVE        | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2<br>Z                 | <a href="#">Samples</a> |
| SN74LVC2T45DCTT   | ACTIVE        | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2<br>Z                 | <a href="#">Samples</a> |
| SN74LVC2T45DCTTE4 | ACTIVE        | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2<br>Z                 | <a href="#">Samples</a> |
| SN74LVC2T45DCTTG4 | ACTIVE        | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2<br>Z                 | <a href="#">Samples</a> |
| SN74LVC2T45DCUR   | ACTIVE        | US8          | DCU                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU SN            | Level-1-260C-UNLIM   | -40 to 85    | (CT2R ~ T2)<br>CZ        | <a href="#">Samples</a> |
| SN74LVC2T45DCURE4 | ACTIVE        | US8          | DCU                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2R                     | <a href="#">Samples</a> |
| SN74LVC2T45DCURG4 | ACTIVE        | US8          | DCU                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2R                     | <a href="#">Samples</a> |
| SN74LVC2T45DCUT   | ACTIVE        | US8          | DCU                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2R                     | <a href="#">Samples</a> |
| SN74LVC2T45DCUTE4 | ACTIVE        | US8          | DCU                | 8    |                | TBD                        | Call TI          | Call TI              | -40 to 85    |                          | <a href="#">Samples</a> |
| SN74LVC2T45DCUTG4 | ACTIVE        | US8          | DCU                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 85    | CT2R                     | <a href="#">Samples</a> |
| SN74LVC2T45YZPR   | ACTIVE        | DSBGA        | YZP                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM   | -40 to 85    | (TB ~ TB7 ~ TBN)         | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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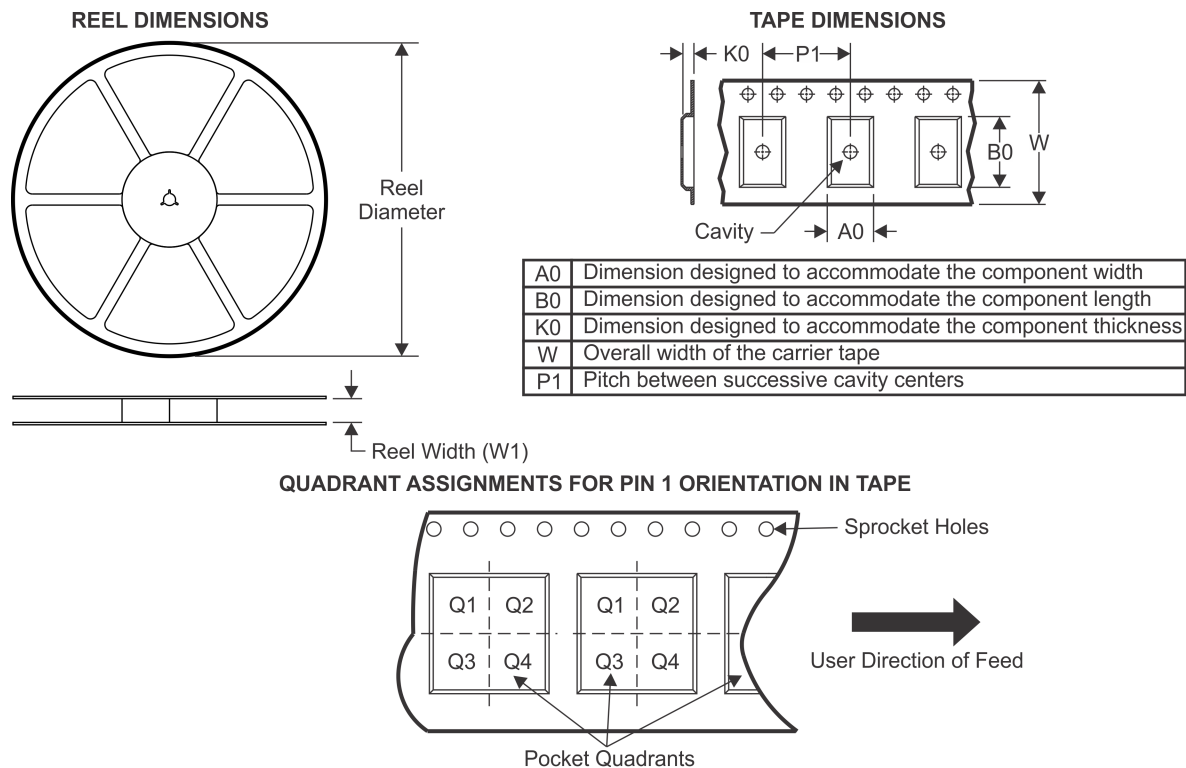
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#### **OTHER QUALIFIED VERSIONS OF SN74LVC2T45 :**

- Automotive: [SN74LVC2T45-Q1](#)
- Enhanced Product: [SN74LVC2T45-EP](#)

NOTE: Qualified Version Definitions:

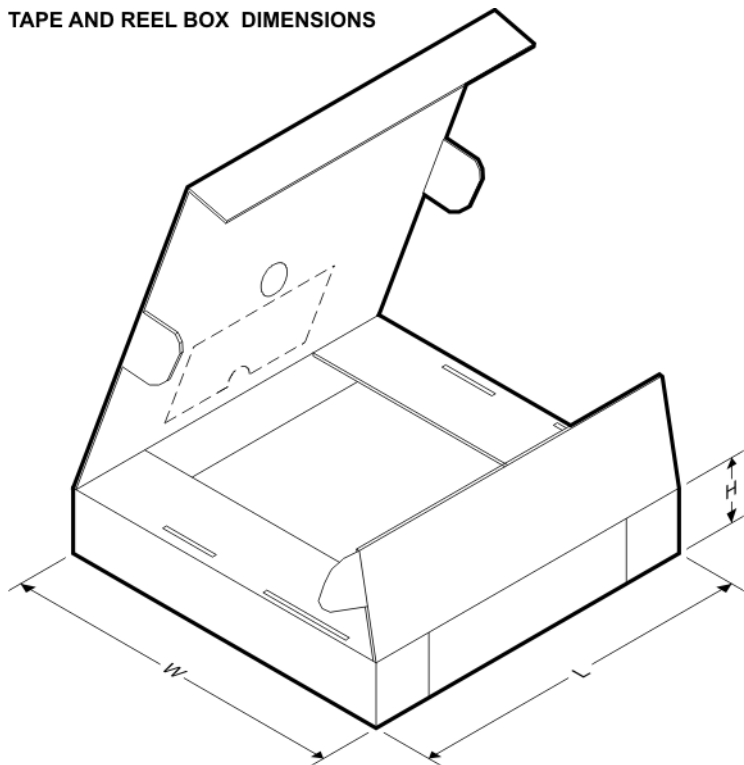
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVC2T45DCUR   | US8          | DCU             | 8    | 3000 | 180.0              | 9.0                | 2.05    | 3.3     | 1.0     | 4.0     | 8.0    | Q3            |
| SN74LVC2T45DCUR   | US8          | DCU             | 8    | 3000 | 180.0              | 8.4                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC2T45DCURG4 | US8          | DCU             | 8    | 3000 | 180.0              | 8.4                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC2T45DCUTG4 | US8          | DCU             | 8    | 250  | 180.0              | 8.4                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 178.0              | 9.2                | 1.02    | 2.02    | 0.63    | 4.0     | 8.0    | Q1            |
| SN74LVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 180.0              | 8.4                | 1.02    | 2.02    | 0.63    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS

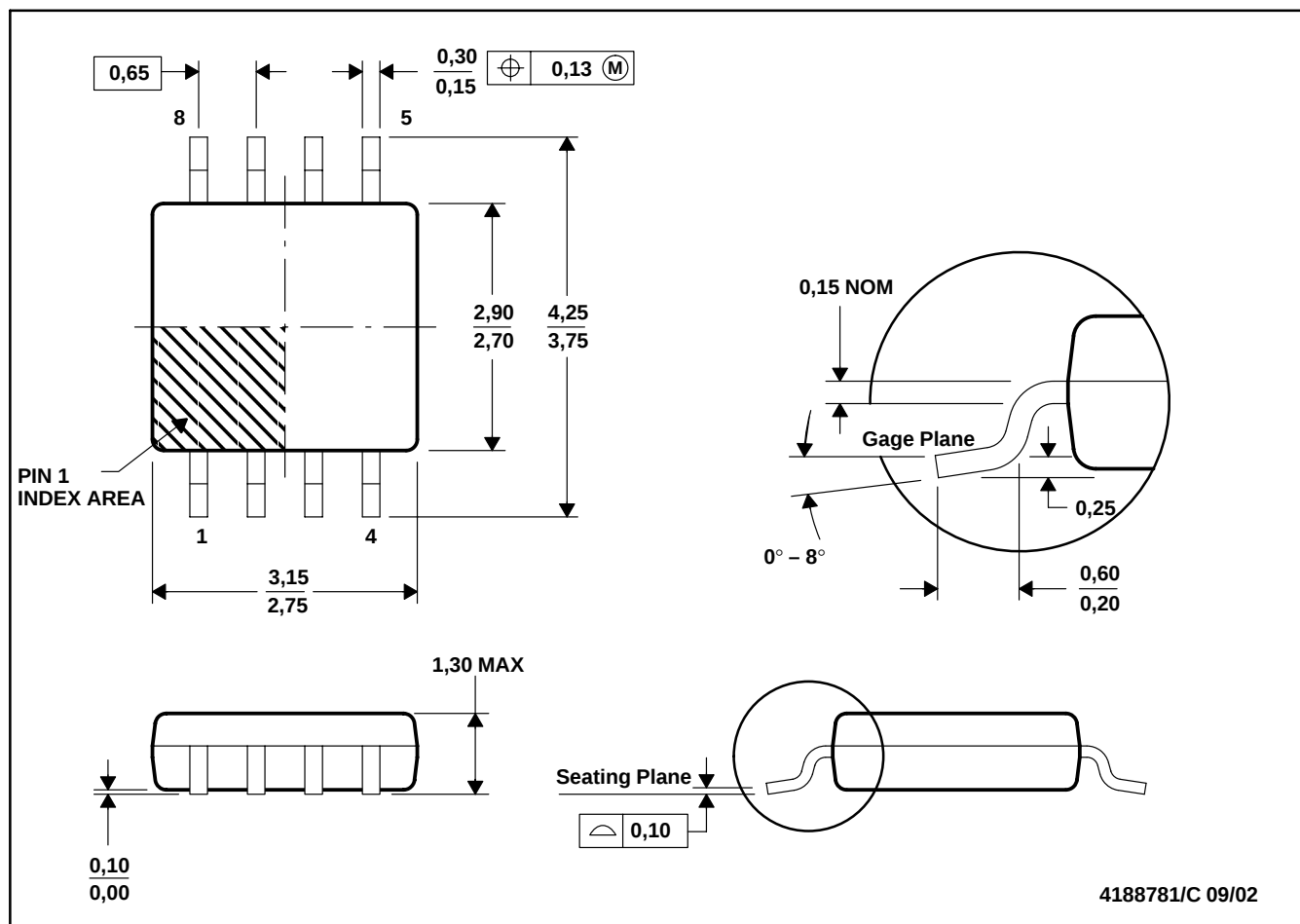


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC2T45DCUR   | US8          | DCU             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| SN74LVC2T45DCUR   | US8          | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74LVC2T45DCURG4 | US8          | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74LVC2T45DCUTG4 | US8          | DCU             | 8    | 250  | 202.0       | 201.0      | 28.0        |
| SN74LVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 220.0       | 220.0      | 35.0        |
| SN74LVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 210.0       | 185.0      | 35.0        |

## DCT (R-PDSO-G8)

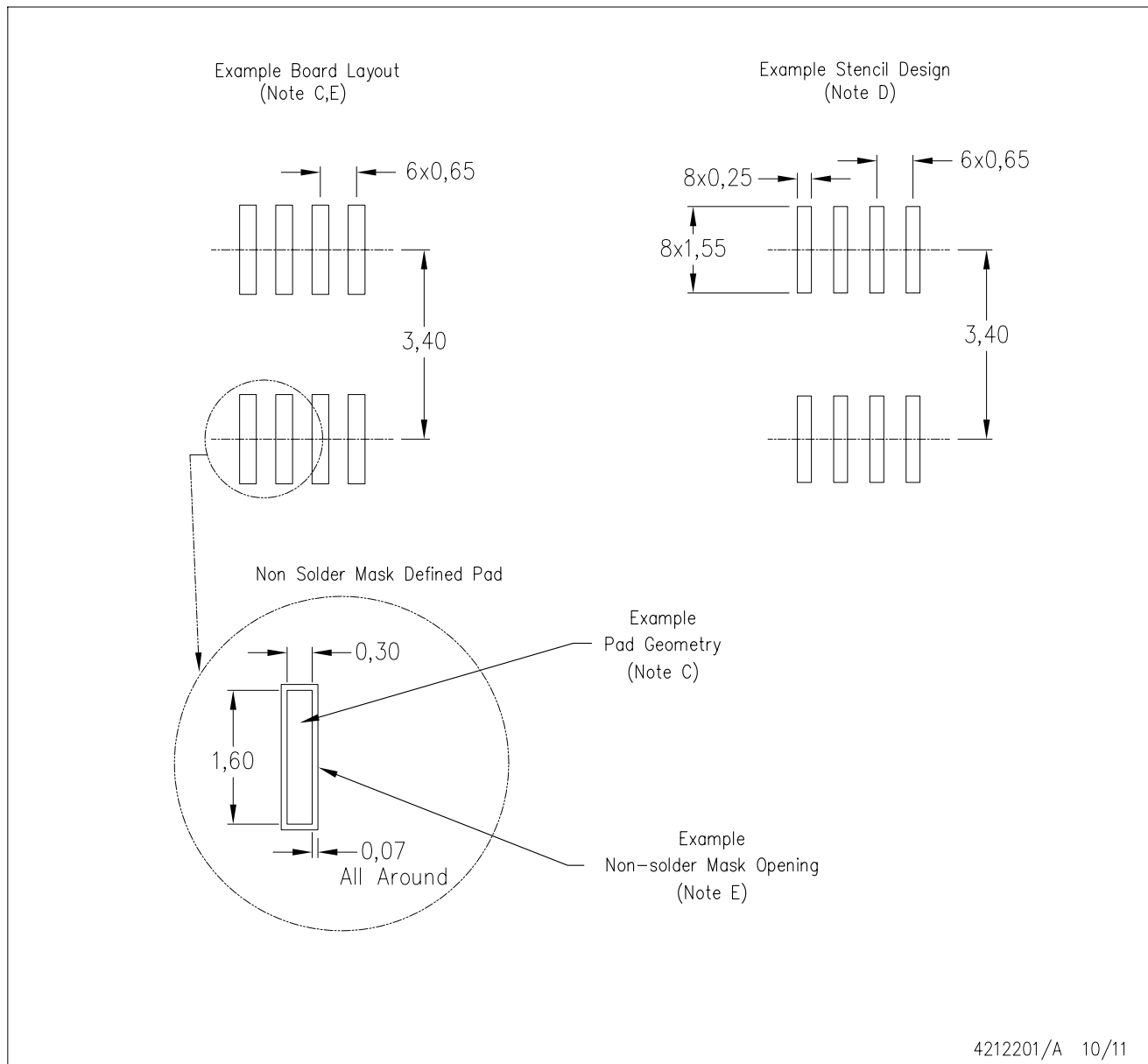
## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion.
  - Falls within JEDEC MO-187 variation DA.

DCT (R-PDSO-G8)

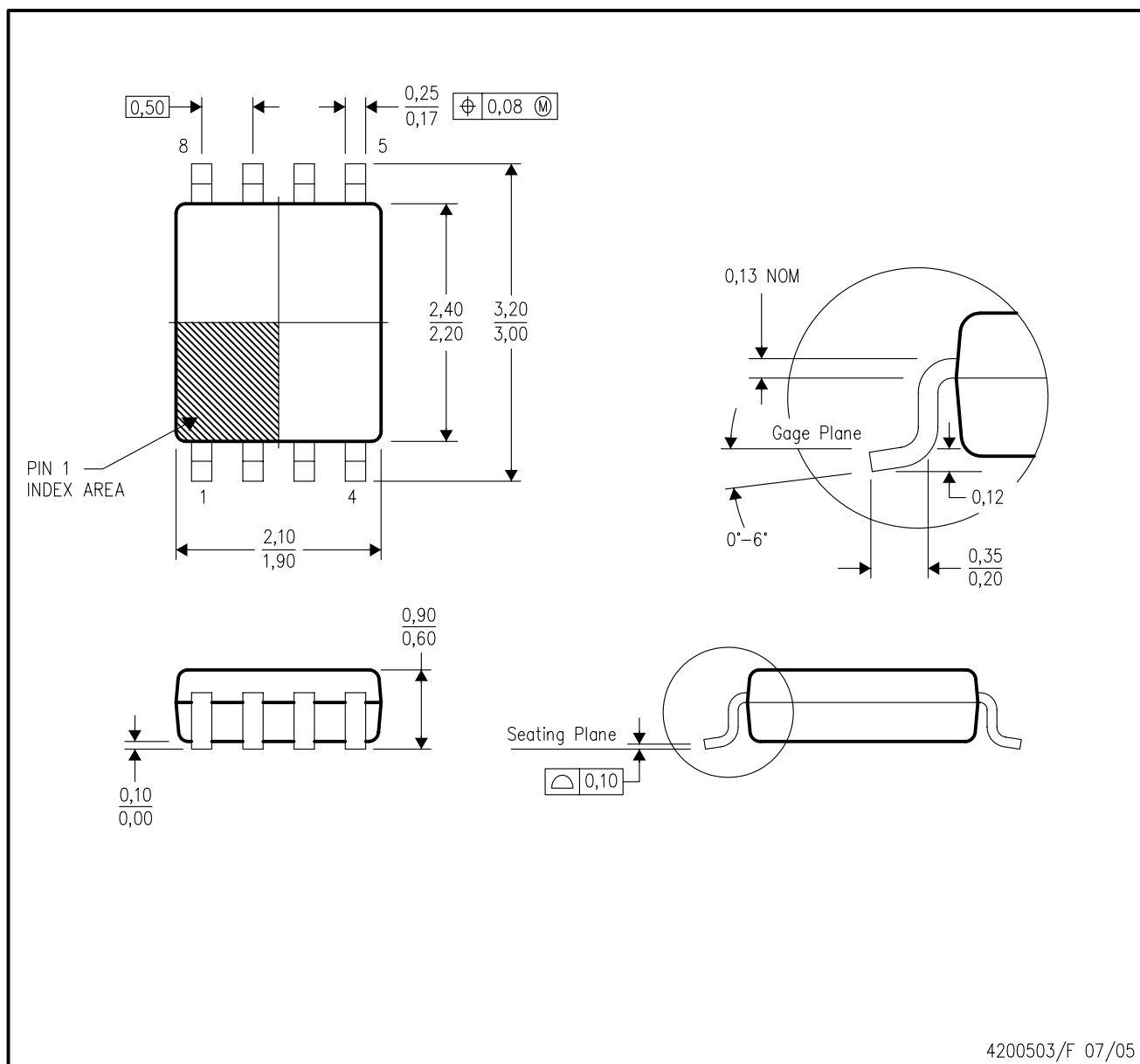
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)

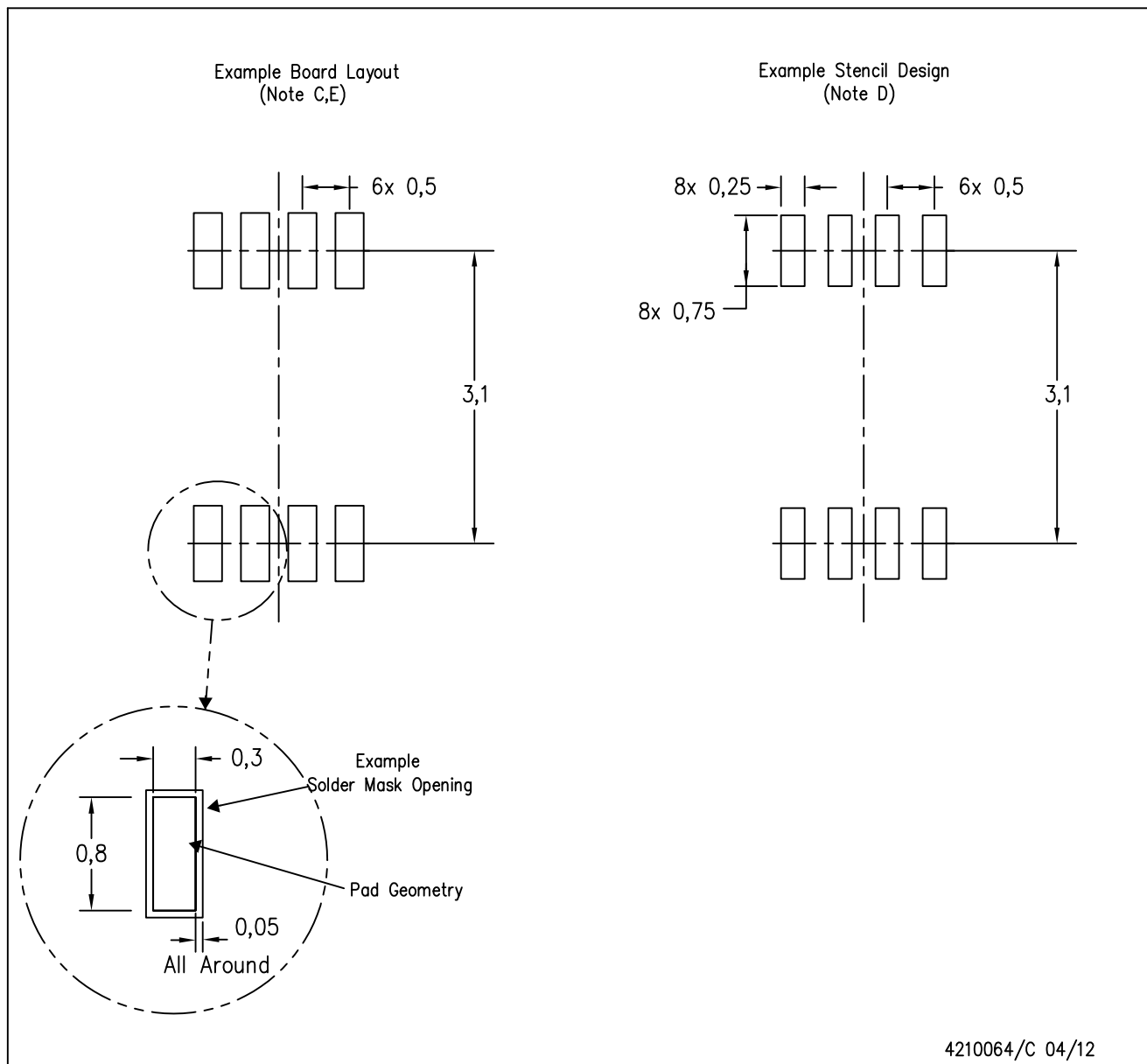


## NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- Falls within JEDEC MO-187 variation CA.

DCU (S-PDSO-G8)

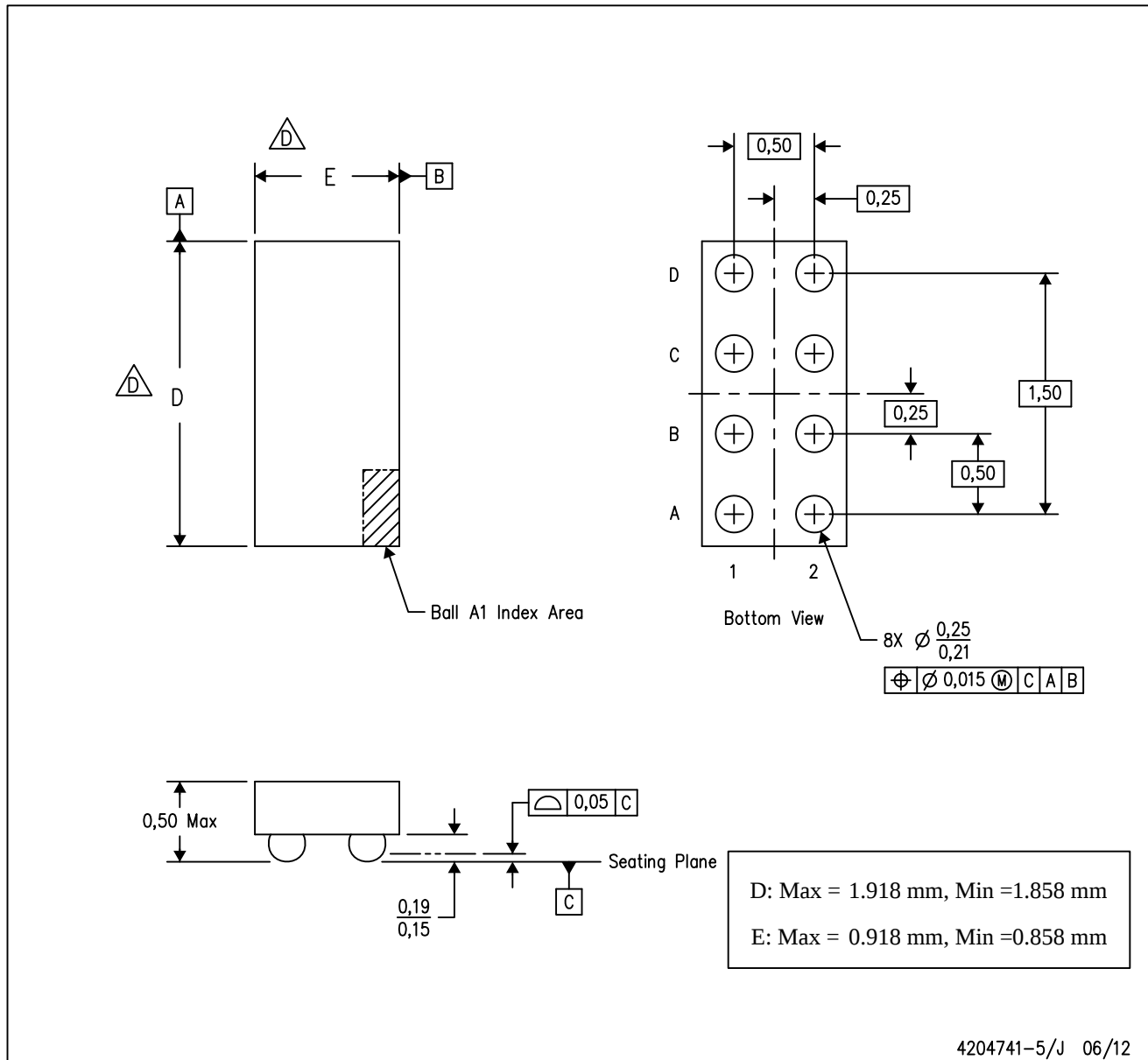
PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.
  - The package size (Dimension D and E) of a particular device is specified in the device Product Data Sheet version of this drawing, in case it cannot be found in the product data sheet please contact a local TI representative.
  - E. This package is a Pb-free solder ball design. Refer to the 8 YEP package (drawing 4204725) for tin-lead (SnPb).

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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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